

Applicant: TESHIMA

Atty. Dkt.: 01-279-CON

Serial No.: 10/787,164

Art Unit: 2826

Filed: 2/27/2004

Examiner: Williams

Title: SEMICONDUCTOR DEVICE

HAVING HEAT CONDUCTING PLATES

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Window, Mail Stop Amendment
Randolph Building
401 Dulany St.
Alexandria, VA 22314

Date: 22 March 2005

## **AMENDMENT UNDER 37 CFR 1.111**

Sir:

In response to the office action mailed 22 November 2004, please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this paper.

Remarks begin on page 4 of this paper.